

Title (en)  
Contact spill.

Title (de)  
Kontaktstift.

Title (fr)  
Fiche de contact.

Publication  
**EP 0234235 A1 19870902 (EN)**

Application  
**EP 87100541 A 19870116**

Priority  
GB 8602310 A 19860130

Abstract (en)  
The contact spill is for use in the manufacture of a backplane provided with a plated-through hole for the reception of the spill. The portion of the spill which co-operates with the plated-through hole is formed in a manner which allows the spill to experience an interference-fit with the hole. The portion is further prepared with a coating to permit the spill to be subjected to a reflow solder process and thereby make a good electrical contact with the plated-through hole.

IPC 1-7  
**H01R 9/09**

IPC 8 full level  
**H01R 4/00** (2006.01); **H01R 4/02** (2006.01); **H01R 4/64** (2006.01); **H01R 12/58** (2011.01); **H05K 3/42** (2006.01)

IPC 8 main group level  
**H01R** (2006.01)

CPC (source: EP)  
**H01R 12/585** (2013.01)

Citation (search report)  
• [A] EP 0088582 A1 19830914 - DU PONT [US]  
• [A] DE 2610537 A1 19760930 - DU PONT  
• [A] US 3827004 A 19740730 - HEUVEL M, et al

Cited by  
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Designated contracting state (EPC)  
BE DE ES FR GR IT LU NL SE

DOCDB simple family (publication)  
**GB 2186124 A 19870805**; **GB 8602310 D0 19860305**; DK 43887 A 19870731; DK 43887 D0 19870127; EP 0234235 A1 19870902; FI 870392 A0 19870129; FI 870392 A 19870731; IE 870115 L 19870730; PT 84210 A 19870201

DOCDB simple family (application)  
**GB 8602310 A 19860130**; DK 43887 A 19870127; EP 87100541 A 19870116; FI 870392 A 19870129; IE 11587 A 19870120; PT 8421087 A 19870128